

Master Bond Epoxy Adhesives, Sealants & Coatings

APPLICATION SELECTOR GUIDE — TWO COMPONENT SERIES

Master Bond Grade	Mix Ratio By Weight	Color Code	Viscosity Mixed, RT, cps	Gel Time Minutes, RT	Cure Schedule Temp./Time, °F	Service Temp. Range	Application Recommendations
EP21	1/1	"A" red "B" amber	20-25,000	90-120	12 hours, RT 20 min. @ 300°F	-60° to +250°F	High performance, durable, tough general purpose mineral filled adhesive and sealant, resistant to thermal cycling, water, oils and chemicals, no-drip application feature.
EP21D	1/1	"A" gray "B" amber	20-25,000	60-75	12 hours, RT 15-20 min. @ 300°F	-60° to +250°F	Faster curing version of EP21.
EP21HV	1/1	"A" gray "B" amber	Flowing paste	90-120	12 hours, RT 20 min. @ 300°F	-60° to +250°F	High viscosity version of EP21.
EP21LP	1/1	"A" clear, yellow "B" amber, clear	5-7,000	240-300	18-24 hours, RT 30 min. @ 300°F	-60° to +250°F	Long pot life (4 hr.) version of EP21 with superior electrical insulation properties.
EP21LV	1/1	"A" gray "B" amber	6-8,000	90-120	12 hours, RT 20 min. @ 300°F	-60° to +250°F	Low viscosity version of EP21 for sealing, castings and encapsulation.
EP21CLV	1/1	"A" clear, yellow "B" amber, clear	5-7,000	90-120	12 hours, RT 20-30 min. @ 300°F	-60° to +250°F	Low viscosity, unfilled version of EP21 for sealing, castings and encapsulation.
EP21AO	1/1	"A" gray "B" amber	Light paste	90-120	12 hours, RT 20 min. @ 300°F	-60° to +250°F	High performance, thermally conductive compound resistant to thermal cycling, water and chemicals; for semiconductor heat sinks and other electronic uses.
EP21ROK	1/1	"A" off-white "B" light tan	Medium viscosity paste	90-120	8-10 hours, RT 20 min. @ 300°F	-60° to +250°F	Durable, tough, "no-skid" flooring, high chemical resistance.
EP21CE	1/0.4	"A" gray "B" amber	3,000	130-160	12 hours, RT 20 min. @ 300°F	-60° to +250°F	Tough, abrasion and impact resistant coating with excellent corrosion resistance.
EP21HT	1/0.6	"A" gray "B" amber	30-40,000	100-120	10 hours, RT 20 min. @ 300°F	-60° to +400°F	High temperature resistant (400°F) version of EP21 with excellent chemical resistant properties.
EP21ND	1/1	"A" gray "B" amber	Light paste	60-75	10 hours, RT 20 min. @ 300°F	-60° to +250°F	High viscosity, no-drip version of EP21 featuring faster cure at ambient temperatures.
EP21N	1/1	"A" gray "B" amber	Paste	90-120	10 hours, RT 20 min. @ 300°F	-60° to +250°F	High viscosity, thixotropic epoxy bonding composition for the abrasive industry.
EP22	1/1	"A" gray "B" amber	18-22,000	90-120	10 hours, RT 20 min. @ 300°F	-60° to +250°F	Aluminum filled epoxy featuring exceptional toughness and impact resistance for high performance bonding.
EP23	1/1	"A" gray "B" amber	20-23,000	90-120	10 hours, RT 20 min. @ 300°F	-60° to +275°F	Special mineral filled epoxy adhesive and sealant with improved thermal and chemical stability.
EP24	1/1	"A" red "B" amber	12-16,000	30-45	8-10 hours, RT 20 min. @ 300°F	-60° to +250°F	Fast curing, high strength epoxy adhesive and sealant for general purpose assembly operations.
EP25	1/1	"A" gray "B" amber	730,000	30-45	8-10 hours, RT 20 min. @ 300°F	-60° to +250°F	Fast curing, high strength, aluminum filled epoxy adhesive and sealant, no-drip application.
EP26	1/1	"A" tan "B" amber	750,000	30-45	8-10 hours, RT 20 min. @ 300°F	-60° to +275°F	Fast curing, high strength mineral filled epoxy adhesive and sealant, no-drip application.

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EP28	1/1	"A" clear tan "B" clear amber	300-350	30-40	10-12 hours, RT 20 min. @ 300°F	-60° to +250°F	Clear low viscosity, fast setting, high strength adhesive/sealant for mechanical assemblies.
EP28M	1/1	"A" clear tan "B" clear amber	300-350	60-70	12 hours, RT 20 min. @ 300°F	-60° to +250°F	Longer pot life (1 hour) version of EP28.
EP29	1/1	"A" gray "B" amber	3-4,000	60-70	12 hours, RT 20 min. @ 300°F	-60° to +250°F	Tough, metal filled epoxy compound for industrial maintenance and repair, machinable, dimensionally stable.
EP30	1/0.25	"A" clear tan "B" clear amber	400-500	30-40	10 hours, RT 20 min. @ 300°F	-60° to +250°F	Low viscosity, fast curing epoxy adhesive/sealant with exceptional adhesion to glass and ceramics.
EP30M	1/0.5	"A" clear tan "B" clear amber	6-6,500	40-50	18-24 hours, RT 20 min. @ 300°F	-60° to +250°F	High strength, medium viscosity adhesive with short pot life for bonding wood, ceramics and metals.
EP30M-1	1/0.5	"A" clear tan "B" clear amber	3-3,500	300-360	24-48 hours, RT 30-40 min. @ 300°F	-60° to +230°F	Long pot life version of EP30M for bonding wood, ceramics and metal, good chemical resistance.
EP30HT	1/0.25	"A" clear tan "B" clear amber	16-18,000	30-40	18-24 hours, RT 20 min. @ 300°F	-60° to +400°F	High temperature resistant version of EP30 system with exceptional adhesion to glass, ceramics and wood, excellent long term durability.
EP30S-1	1/0.3	"A" clear tan "B" clear amber	5-6,000	40-45	18-24 hours, RT 20 min. @ 300°F	-60° to +240°F	Medium viscosity version of EP30 with improved toughness and thermal shock resistance.
EP30DP8	1/0.2	"A" clear tan "B" clear amber	30-40,000	10-15	8-12 hours, RT 20 min. @ 250°F	-80° to +250°F	Tough flexible adhesive/sealant with excellent electrical insulation properties.
EP30DP8LV	1/0.2	"A" clear tan "B" light amber	8-10,000	30-40	18-24 hours, RT 30 min. @ 250°F	-80° to +250°F	Low viscosity version of EP30DP8 for use in sealing and encapsulating electronic components.
EP30DP8FIT	1/0.2	"A" gray "B" light amber	Light thixotropic paste	45-60	18-24 hours, RT 30 min. @ 250°F	-80° to +250°F	Tough, flexible adhesive/sealant for concrete expansion joints and other construction applications; 100% reactive.
EP30DP9	1/0.15	"A" gray "B" light gray	Light thixotropic paste	40-50	18-24 hours, RT 30 min. @ 250°F	-80° to +250°F	Abrasion resistant, tough elastomeric lining with excellent adhesion to metals, concrete and wood; 100% reactive.
EP30DP9T2	1/0.15	"A" red "B" gray	Thixotropic paste	30-40	18-24 hours, RT 30 min. @ 250°F	-80° to +250°F	Abrasion resistant, tough elastomeric lining with excellent chemical resistance; 100% reactive.
EP30DP4X-2	63/37	"A" black "B" amber	5-6,000	80-100	18-24 hours, RT 30 min. @ 250°F	-80° to +230°F	Tough, flexible sealant and encapsulant with excellent water resistance and superior electrical insulation properties.
EP33	1/0.7	"A" gray "B" amber	Light paste	120-140	24-36 hours, RT 60-90 min. @ 300°F	-60° to +450°F	High temperature resistant adhesive/sealant with excellent physical strength properties and room temperature curing capabilities, high dimensional stability.
EP33LV	1/0.7	"A" gray "B" amber	25-30,000	90-120	24-36 hours, RT 60-90 min. @ 300°F	-60° to +450°F	Medium viscosity version of EP33 high temperature resistant epoxy system.
EP33CLV	1/0.7	"A" clear tan "B" clear amber	4-5,000	90-120	24-36 hours, RT 60-90 min. @ 300°F	-60° to +450°F	Low viscosity, unfilled version of EP33 high temperature resistant epoxy system.
EP34	1/0.7	"A" gray "B" amber	Light paste	130-150	24-36 hours, RT 70-100 min. @ 300°F	-60° to +450°F	High temperature resistant adhesive/sealant featuring superior electrical insulating properties and room temperature curing capabilities.

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EP34LV	1/0.5	"A" gray "B" amber	25-30,000	120-140	70-100 min. @ 300°F	-60° +450°F	Medium viscosity version of EP33 epoxy system for high temperature potting and encapsulation application.
EP34CA	1/0.5	"A" clear tan "B" clear amber	5,300-5,800	400-500	1) 60 min. @ 230°F (Gel) 2) 60-120 min. @ 300°F 3) Optional post-cure @ 390-400°F	-60° to +450°F	Heat resistant laminating resin for filament winding of structural FRP components.
EP34CLV	1/0.7	"A" clear tan "B" clear amber	6-65,000	130-150	24-36 hours, RT 70-100 min. @ 300°F	-60° to +450°F	Low viscosity version of EP33 high temperature resistant system epoxy.
EP35	1/0.7	"A" gray "B" amber	80-120,000	120-140	24-36 hours, RT 70-100 min. @ 300°F	-60° to +450°F	High temperature resistant, toughened adhesive/sealant with room temperature curing capability.
EP35LV	1/0.7	"A" gray "B" amber	25-30,000	120-140	24-36 hours, RT 70-100 min. @ 300°F	-60° to +450°F	High temperature resistant toughened epoxy system for high temperature potting and encapsulation.
EP35CLV	1/0.7	"A" clear tan "B" clear amber	5,300-5,700	120-150	24-36 hours, RT 70-100 min. @ 300°F	-60° to +450°F	Low viscosity version of EP35, high temperature resistant epoxy system.
EP39M	1/0.75	"A" black "B" clear dk. brn.	4-5,000	120-150	24-36 hours, RT 70-100 min. @ 300°F	-60° to +350°F	Heat resistant adhesive/coating and encapsulant for capacitors and other electronic components.
EP41	1/0.60	"A" black "B" clear dk. brn.	15-18,000	120-150	24-48 hours, RT 60-75 min. @ 300°F	-60° to +300°F	Tough, corrosion resistant epoxy resin coating system with excellent adhesion to metals, concrete and wood.
EP41CLV	1/0.60	"A" black "B" clear dk. brn.	6-8,000	120-150	24-48 hours, RT 60-75 min. @ 300°F	-60° to +300°F	Low viscosity, unfilled version of EP41 epoxy resin system, high corrosion resistance.
EP41T	1/0.60	"A" black "B" clear dk. brn.	Thixotropic paste	120-150	24-48 hours, RT 60-75 min. @ 300°F	-60° to +300°F	Thixotropic paste version of EP41 epoxy resin system for lining of chemical tanks, excellent durability.
EP41HT	1/0.60	"A" black "B" clear dk. brn.	35-40,000 paste	120-150	24-48 hours, RT 60-75 min. @ 300°F	-60° to +400°F	Heat resistant version of EP41 epoxy resin system.
EP41-IND	1/0.60	"A" black "B" gray	Light paste	120-150	24-48 hours, RT 60-75 min. @ 300°F	-60° to +350°F	Abrasion resistant version of EP41 epoxy resin system with maximum chemical resistance.
EP45	1/0.30	"A" tan "B" amber	Light paste	200-250	24-48 hours, RT 60-75 min. @ 300°F	-80° to +300°F	High performance structural bonding; meets MIL-MMM-A-132 type II.
EP50	1/0.5	"A" clear tan "B" clear dk. brn.	5-6,000	45 sec.	5 min. @ RT	-60° to +250°F	Super high-speed curing adhesive for structural bonding and in the construction industry.
EP51	1/1	"A" gray or red "B" amber	10-12,000	5 min.	6-10 hours, RT 15-20 min. @ 300°F	-60° to +250°F	Fast curing "5 min. epoxy" for general purpose bonding, excellent long term durability.
EP51T	1/1	"A" black "B" amber	Light paste	5 min.	6-10 hours, RT 15-20 min. @ 300°F	-60° to +250°F	High viscosity, thixotropic version of EP51 epoxy resin system, no-drip application feature.
EP51HT	1/1	"A" gray "B" amber	Light paste	5 min.	6-10 hours, RT 15-20 min. @ 300°F	-60° to +350°F	Heat resistant (350°) version of EP51 epoxy resin system, superior dimensional stability.
EP51FL	1/1	"A" gray "B" amber	12-15,000	5 min.	6-10 hours, RT 15-20 min. @ 300°F	-60° to +250°F	Toughened version of EP51 epoxy resin system with high thermal shock resistance, fast cure.

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EP51M	1/1	"A" gray or red "B" amber	10-12,000	3 min.	6-8 hours, RT 10-15 min. @ 300°F	-60° to +250°F	"3 minutes" gel version of EP51 epoxy resin system.
EP62	1/0.08	"A" clear tan "B" clear amber	2,800-3,200	7 days. @ RT	½-1 hour. @ 170°F	-69° to +300°F	Long pot life (7 days at RT) high performance epoxy adhesive sealant; cures at 170°F.
EP62M	1/0.08	"A" clear tan "B" clear amber	2,500-2,800	7 days. @ RT	½-1 hour. @ 170°F	-60° to +300°F	Flexibilized version of EP62 epoxy resin system.
EP65	1/0.10	"A" clear tan "B" clear dk. brn.	10-12,000	15-20	1-2 hours, RT 10-15 min. @ 200°F	-60° to +300°F	High speed structural adhesive for the audio industry.
EP72	1/1	"A" clear tan "B" gray	15-18,000	30-45	12-24 hours, RT 20-30 min. @ 300°F	-60° to +300°F	Elastomer (polysulfide) modified high strength epoxy adhesive/sealant.
EP72AO	1/1	"A" gray "B" tan	30-40,000	30-45	12-24 hours, RT 20-30 min. @ 300°F	-60° to +300°F	Abrasion resistant version of EP72 modified epoxy resin system for tank linings.
EP72M3	1/1	"A" gray "B" clear amber	20-30,000	45-60	12-24 hours, RT 20-30 min. @ 300°F	-60° to +275°F	Toughened high strength epoxy adhesive/sealant with excellent thermal shock resistance.
EP73	0.60/1.0	"A" gray "B" clear tan	25-30,000	90-120	12-24 hours, RT 30-40 min. @ 300°F	-60° to +275°F	Tough, flexible, high strength, water resistant epoxy adhesive/sealant, superior impact resistance.
EP74	1.0/0.4	"A" red "B" dark clear	8-10,000	90-120	12-24 hours, RT 30-40 min. @ 300°F	-60° to +300°F	Toughened high strength epoxy resin adhesive/sealant with high corrosion resistance.
EP75	1.0/0.07	"A" black "B" clear amber	Light paste	45-60	12-24 hours, RT 20-30 min. @ 300°F	-60° to +300°F	Electrically conductive (graphite filled) epoxy adhesive/sealant.
EP76	1.0/0.05	"A" gray "B" clear	Light paste	45-60	12-24 hours, RT 20-30 min. @ 300°F	-60° to +300°F	Electrically conductive (nickel filled) epoxy adhesive/sealant.
EP76M	1/1	"A" gray "B" gray	Light paste	45-60	12-24 hours, RT 20-30 min. @ 300°F	-60° to +300°F	Electrically conductive (nickel filled) epoxy adhesive/sealant; convenient mix ratio.
EP91	1/0.2	"A" clear tan "B" clear amber	8-10,000	Forms storage stable B stage @ RT	60-120 min. @ 275-300°F	-60° to +300°F	EP91 forms non-tacky storage, stable (6 months) "B" stage at RT; cure completed at 275°-300°F.
EP110	0.7/1.0	"A" clear tan "B" clear amber	5,000	Stable @ RT for 4-6 weeks	60-90 min. @ 250°F 160-200 min. @ 300°F	-60° to +300°F	Casting and encapsulating compound for electrical/electronic components.
Supreme 11	1/1	"A" gray "B" clear amber	16-20,000	40-50	18-24 hours, RT 20 min. @ 300°F	-60° to +275°F	High peel strength, high performance epoxy adhesive system, excellent thermal shock resistance.
Supreme 11 HT	1/1	"A" gray "B" clear amber	22-25,000	35-45	12-16 hours, RT 15 min. @ 300°F	-60° to +400°F	Heat resistant version of Supreme 11.
EP30D-7	1/0.15	"A" gray "B" amber	20-25,000	35-45	18-24 hours, RT 30 min. @ 250°F	-60° to +250°F	Two component high strength elastomer for sealing, potting and encapsulation.
EP30D-9	1/0.15	"A" gray "B" amber	Light paste	50-60	18-24 hours, RT 30 min. @ 250°F	-60° to +250°F	Two component abrasion resistant elastomer for potting, encapsulation and protective liners.

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Master Bond Epoxy Adhesives, Sealants & Coatings

APPLICATION SELECTOR GUIDE — ONE COMPONENT SERIES

Master Bond Grade	Viscosity cps, RT	Color Code	Storage Stability, RT	Gel Time Minutes	Cure Schedule Minutes	Service Temp. Range, Continuous	Application Recommendations
EP3	90-100,000	Brown	6 Months Minimum	2 min. @ 250°F 50 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +250°F	Fast curing general purpose adhesive/sealant with superior mechanical and electrical properties, corrosion resistant.
EP4	Paste	Gray	6 Months Minimum	2 min. @ 250°F 50 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +250°F	Aluminum filled system for durable tough, weather resistant joining and sealing of mechanical components, good dimensional stability.
EP5	Paste	Gray	6 Months Minimum	2 min. @ 250°F 50 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +250°F	High strength, shock resistant adhesives and sealants for mechanical and electrical parts.
EP6	Paste	Gray	6 Months Minimum	2 min. @ 250°F 60 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +300°F	High toughness and superior heat resistance.
EP7	Paste	Cream	6 Months Minimum	2 min. @ 250°F 60 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +275°F	Non-metallic filled composition for superior electrical insulation and corrosion resistant.
EP8	50-60,000	Tan	6 Months Minimum	2½ min. @ 250°F 80 sec. @ 300°F	30-40 min. @ 250°F 10-15 min. @ 300°F	-60° to +250°F	Low viscosity version of EP3, easy application.
EP9	50-60,000	Tan	6 Months Minimum	2½ min. @ 250°F 80 sec. @ 300°F	30-40 min. @ 250°F 10-15 min. @ 300°F	-60° to +230°F	Flexibilized low viscosity version of EP3 for highest toughness.
EP11	10-12,000	Brown	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +350°F	High strength, low viscosity compound with excellent electrical insulation properties and superior corrosion resistance.
EP11HT	75-85,000	Tan	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +350°F	Heat resistant version of EP11HT.
EP11ET	5-6,000	Tan	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +350°F	Lower viscosity version of EP11.
EP11EET	2-3,000	Tan	6 Months Minimum	20-30 min. @ 300°F	70-90 min. @ 300°-350°F	-60° to +325°F	Special extra low viscosity version of EP11 for impregnation and coating of electrical/electronic components.
EP12	750,000	Brown	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +350°F	High toughness, thermal shock resistant adhesive/sealant, superior strength and chemical resistance.
EP13	Paste	Gray	6 Months Minimum	15-20 min. @ 280°F	60-80 min. @ 300°-350°F	-60° to +400°F	Heat resistant, high strength adhesive/sealant for structural bonding of mechanical and electrical components.
EP14	Paste	Gray	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +350°F	Durable high performance compound with excellent dimensional stability over wide service temperature range.
EP15	Paste	Brown	6 Months Minimum	15-20 min. @ 300°F	60-80 min. @ 300°-350°F	-60° to +375°F	Mineral filled system featuring high heat resistance, excellent electrical insulation properties, superior dimensional stability.

Master Bond Grade	Viscosity cps, RT	Color Code	Storage Stability, RT	Gel Time Minutes	Cure Schedule Minutes	Service Temp. Range, Continuous	Application Recommendations
EP16	12-14,000	Brown	1-2 Days	10 min. @ 212°F	60 min. @ 212°F	-60° to +275°F	Longer RT pot life facilitates production and assembly of capacitors and other electronic components, coil impregnation, laminates and coatings.
EP17	12-14,000	Brown	2-2½ Months	20 min. @ 270°F	60 min. @ 270°F	-60° to +300°F	Long RT pot life advantageous for volume production and assembly of electronic components, impregnation of coils, laminates, insulating varnishes.
EP18	10-12,000	Brown	4 Months	20 min. @ 300°F	60 min. @ 300°F	-60° to +350°F	Prolonged pot life improves cost effectiveness of production and assembly of ferrites, capacitors, coil impregnation, laminates and other electrical components.
EP19	6-8,000	Brown	4 Months	20 min. @ 300°F	60 min. @ 300°F	-60° to +350°F	Lower viscosity version of EP18 especially suited for impregnation and coating operations.
EP20	10-10,200	Brown	Greater than 6 months	20-30 min. @ 300°F	2 hr. @ 300°F plus 2 hr. @ 350°F	-60° to +350°F	Very long pot life version of EP18, excellent electrical insulation properties over a wide temperature range.
EP36	Solid at RT, melts at 180°F, very low viscosity when molten	Brown	3 Months Minimum	1-1½ hr. @ 300°-325°F	3-4 hrs. @ 300°-325°F	-80° to +500°F	Extra tough, heat resistant, excellent electrical insulating properties; employed for heat resistant coating, bonding, potting and encapsulation of electronic components.
Supreme 10	30-35,000	Gray	6 Months Minimum	20 min. @ 300°F	60 min. @ 325°-350°F	-60° to +350°F	High performance adhesive/sealant for structural bonding featuring high peel strength and outstanding thermal shock resistance.
Supreme 10 S-1	30-35,000	Gray	6 Months Minimum	20 min. @ 300°F	60 min. @ 325°-350°F	-60° to +350°F	High peel strength adhesive/sealant with outstanding performance profile designed for electrical insulation uses.
Supreme 10G	750,000	Gray	6 Months Minimum	20 min. @ 300°F	60 min. @ 325°-350°F	-60° to +400°F	Heat resistant version of Supreme 10; suitable for service up to 400°F.
Supreme 10LV	5-6,000	Tan	6 Months Minimum	20 min. @ 300°F	60 min. @ 325°-350°F	-60° to +350°F	Low viscosity version of Supreme 10; for impregnation, coating and bonding uses.
Supreme 10EET	2-3,000	Tan	4 Months Minimum	25-35 min. @ 275°-300°F	60 min. @ 300°-325°F	-60° to +325°F	Extra low viscosity version of Supreme 10; for impregnation and coating application.
Supreme 10TI	Paste	Gray	6 Months Minimum	20 min. @ 300°F	60 min. @ 300°-325°F	-60° to +350°F	Paste version of Supreme 10; no-drip application feature.
Supreme 3	100,000	Tan	6 Months Minimum	2 min. @ 250°F 50 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-80° to +250°F	High peel strength version of EP3 with extra thermal shock properties and superior low temperature service characteristics.
Supreme 3T	Paste	Tan	6 Months Minimum	2 min. @ 250°F 50 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-80° to +250°F	High peel strength version of EP3 with no-drip application feature.
Supreme 3HT	150,000	Tan	6 Months Minimum	1½ min. @ 250°F 45 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +350°F	High peel strength, heat resistant version of EP3.
EP3FL	150,000	Tan	4 Months Minimum	2 min. @ 250°F 60 sec. @ 300°F	30 min. @ 250°F 10 min. @ 300°F	-60° to +250°F	Highly flexible (elastomeric) version of EP3; coating, potting and encapsulation uses.

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